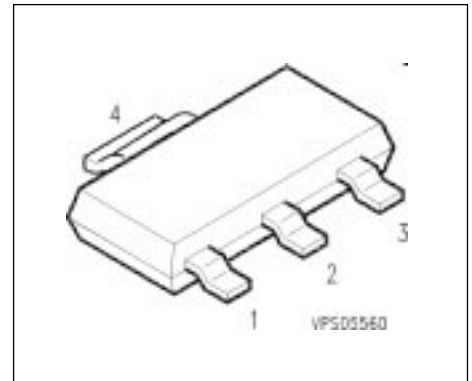


## SIPMOS<sup>®</sup> Small-Signal Transistor

- P channel
- Enhancement mode
- Logic Level
- Avalanche rated
- $V_{GS(th)} = -0.8 \dots -2.0 \text{ V}$



|       |       |       |       |
|-------|-------|-------|-------|
| Pin 1 | Pin 2 | Pin 3 | Pin 4 |
| G     | D     | S     | D     |

| Type    | $V_{DS}$ | $I_D$  | $R_{DS(on)}$  | Package | Marking |
|---------|----------|--------|---------------|---------|---------|
| BSP 171 | -60 V    | -1.7 A | 0.35 $\Omega$ | SOT-223 | BSP 171 |

| Type    | Ordering Code | Tape and Reel Information |
|---------|---------------|---------------------------|
| BSP 171 | Q67000-S224   | E6327                     |

### Maximum Ratings

| Parameter  | Symbol      | Values   | Unit |
|--|-------------|----------|------|
| Continuous drain current<br>$T_A = 24 \text{ }^\circ\text{C}$  | $I_D$       | -1.7     | A    |
| DC drain current, pulsed<br>$T_A = 25 \text{ }^\circ\text{C}$  | $I_{Dpuls}$ | -6.8     |      |
| Avalanche energy, single pulse<br>$I_D = -1.7 \text{ A}$ , $V_{DD} = -25 \text{ V}$ , $R_{GS} = 25 \text{ } \Omega$<br>$L = 3.23 \text{ mH}$ , $T_j = 25 \text{ }^\circ\text{C}$ | $E_{AS}$    | 8        | mJ   |
| Gate source voltage  | $V_{GS}$    | $\pm 20$ | V    |
| Power dissipation<br>$T_A = 25 \text{ }^\circ\text{C}$   | $P_{tot}$   | 1.8      | W    |

## Maximum Ratings

| Parameter  | Symbol     | Values        | Unit |
|--|------------|---------------|------|
| Chip or operating temperature                              | $T_j$      | -55 ... + 150 | °C   |
| Storage temperature  | $T_{stg}$  | -55 ... + 150 |      |
| Thermal resistance, chip to ambient air <sup>1)</sup>      | $R_{thJA}$ | ≤ 70          | K/W  |
| Thermal resistance, junction-soldering point <sup>1)</sup> | $R_{thJS}$ | ≤ 10          |      |
| DIN humidity category, DIN 40 040                          |            | E             |      |
| IEC climatic category, DIN IEC 68-1                        |            | 55 / 150 / 56 |      |

1) Transistor on epoxy pcb 40 mm x 40 mm x 1,5 mm with 6 cm<sup>2</sup> copper area for drain connection

## Electrical Characteristics, at $T_j = 25^\circ\text{C}$ , unless otherwise specified

| Parameter | Symbol | Values |      |      | Unit |
|-----------|--------|--------|------|------|------|
|           |        | min.   | typ. | max. |      |

### Static Characteristics

|  |               |      |             |            |    |
|--|---------------|------|-------------|------------|----|
| Drain- source breakdown voltage<br>$V_{GS} = 0 \text{ V}, I_D = -0.25 \text{ mA}, T_j = 25^\circ\text{C}$  | $V_{(BR)DSS}$ | -60  | -           | -          | V  |
| Gate threshold voltage<br>$V_{GS} = V_{DS}, I_D = -1 \text{ mA}$   | $V_{GS(th)}$  | -0.8 | -1.4        | -2         |    |
| Zero gate voltage drain current<br>$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 25^\circ\text{C}$<br>$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 125^\circ\text{C}$ | $I_{DSS}$     | -    | -0.1<br>-10 | -1<br>-100 | μA |
| Gate-source leakage current<br>$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$  | $I_{GSS}$     | -    | -10         | -100       |    |
| Drain-Source on-state resistance<br>$V_{GS} = -10 \text{ V}, I_D = -1.7 \text{ A}$   | $R_{DS(on)}$  | -    | 0.22        | 0.35       | Ω  |

**Electrical Characteristics, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified**

| Parameter | Symbol | Values |      |      | Unit |
|-----------|--------|--------|------|------|------|
|           |        | min.   | typ. | max. |      |

**Dynamic Characteristics**

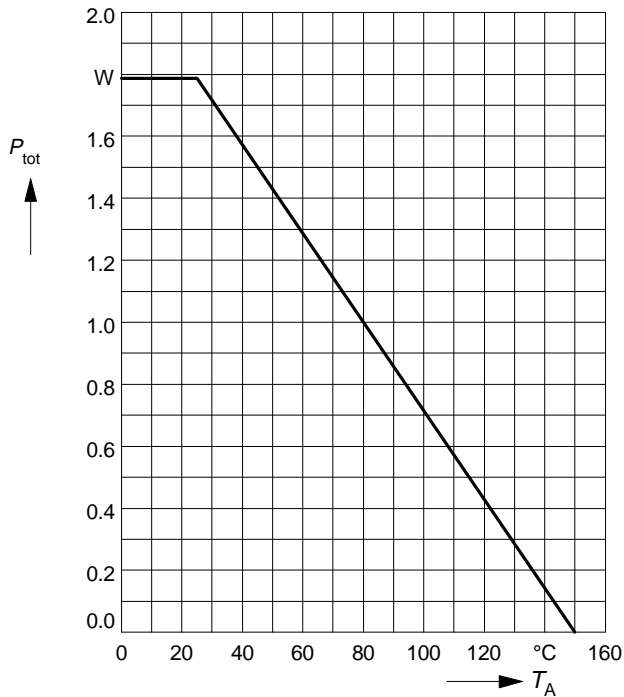
|  |              |   |      |     |    |
|--|--------------|---|------|-----|----|
| Transconductance<br>$V_{DS} \geq 2 * I_D * R_{DS(on)max}, I_D = -1.7 \text{ A}$                                      | $g_{fs}$     | 1 | 1.55 | -   | S  |
| Input capacitance<br>$V_{GS} = 0 \text{ V}, V_{DS} = -25 \text{ V}, f = 1 \text{ MHz}$                               | $C_{iss}$    | - | 720  | 960 | pF |
| Output capacitance<br>$V_{GS} = 0 \text{ V}, V_{DS} = -25 \text{ V}, f = 1 \text{ MHz}$                              | $C_{oss}$    | - | 290  | 435 |    |
| Reverse transfer capacitance<br>$V_{GS} = 0 \text{ V}, V_{DS} = -25 \text{ V}, f = 1 \text{ MHz}$                    | $C_{rss}$    | - | 120  | 180 |    |
| Turn-on delay time<br>$V_{DD} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -0.3 \text{ A}$<br>$R_{GS} = 50 \Omega$ | $t_{d(on)}$  | - | 16   | 25  | ns |
| Rise time<br>$V_{DD} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -0.3 \text{ A}$<br>$R_{GS} = 50 \Omega$          | $t_r$        | - | 70   | 105 |    |
| Turn-off delay time<br>$V_{DD} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = 0.3 \text{ A}$<br>$R_{GS} = 50 \Omega$ | $t_{d(off)}$ | - | 230  | 310 |    |
| Fall time<br>$V_{DD} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -0.3 \text{ A}$<br>$R_{GS} = 50 \Omega$          | $t_f$        | - | 280  | 375 |    |

**Electrical Characteristics**, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified

| Parameter   | Symbol   | Values |      |      | Unit          |
|---|----------|--------|------|------|---------------|
|   |          | min.   | typ. | max. |               |
| <b>Reverse Diode</b>  |          |        |      |      |               |
| Inverse diode continuous forward current<br>$T_A = 25^\circ\text{C}$                                      | $I_S$    | -      | -    | -1.7 | A             |
| Inverse diode direct current, pulsed<br>$T_A = 25^\circ\text{C}$  | $I_{SM}$ | -      | -    | -6.8 |               |
| Inverse diode forward voltage<br>$V_{GS} = 0\text{ V}$ , $I_F = -3.4\text{ A}$ , $T_j = 25^\circ\text{C}$ | $V_{SD}$ | -      | -0.9 | -1.2 | V             |
| Reverse recovery time<br>$V_R = 30\text{ V}$ , $I_F = I_S = 0$ , $di_F/dt = 100\text{ A}/\mu\text{s}$     | $t_{rr}$ | -      | 300  | -    | ns            |
| Reverse recovery charge<br>$V_R = 30\text{ V}$ , $I_F = I_S = 0$ , $di_F/dt = 100\text{ A}/\mu\text{s}$   | $Q_{rr}$ | -      | 0.82 | -    | $\mu\text{C}$ |

### Power dissipation

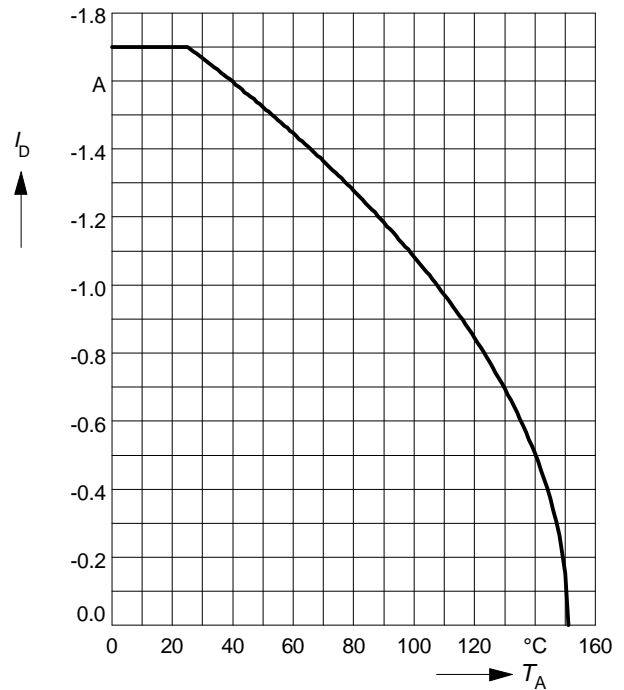
$$P_{\text{tot}} = f(T_A)$$



### Drain current

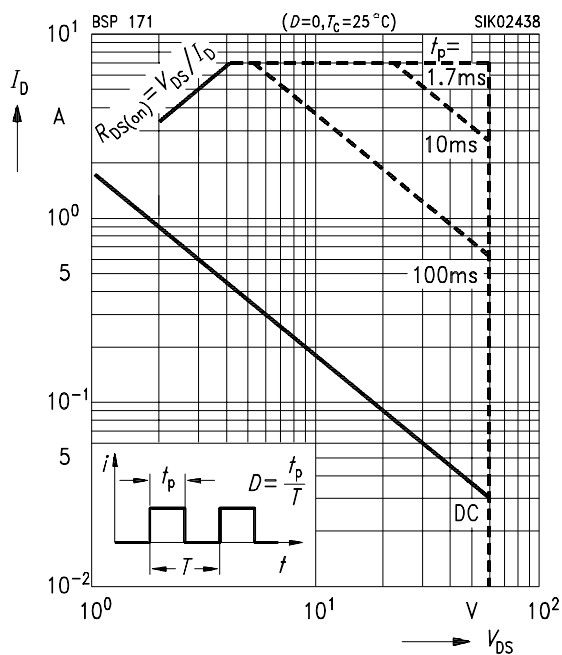
$$I_D = f(T_A)$$

parameter:  $V_{GS} \geq -10 \text{ V}$



### Safe operating area $I_D = f(V_{DS})$

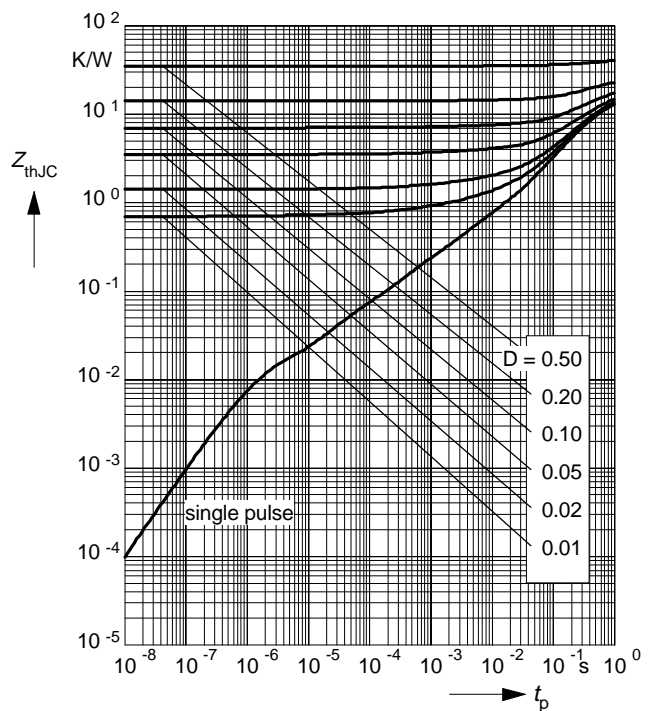
parameter:  $D = 0, T_C = 25^\circ\text{C}$



### Transient thermal impedance

$$Z_{\text{thJA}} = f(t_p)$$

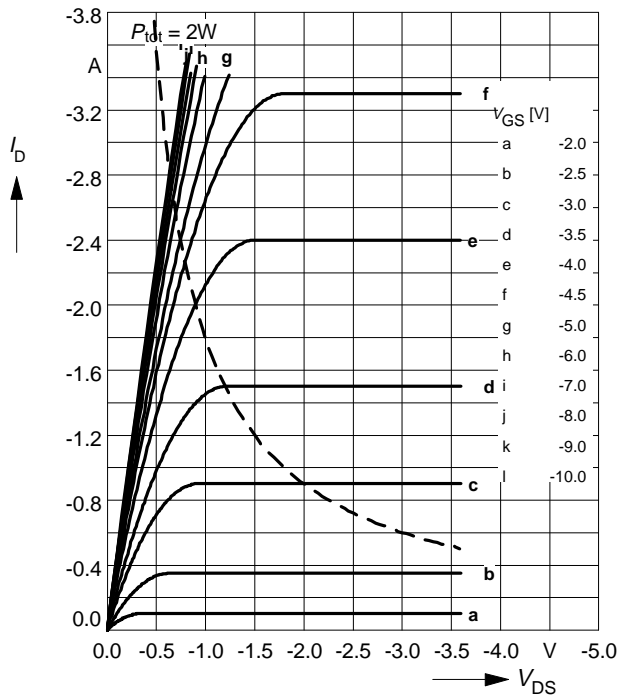
parameter:  $D = t_p / T$



### Typ. output characteristics

$$I_D = f(V_{DS})$$

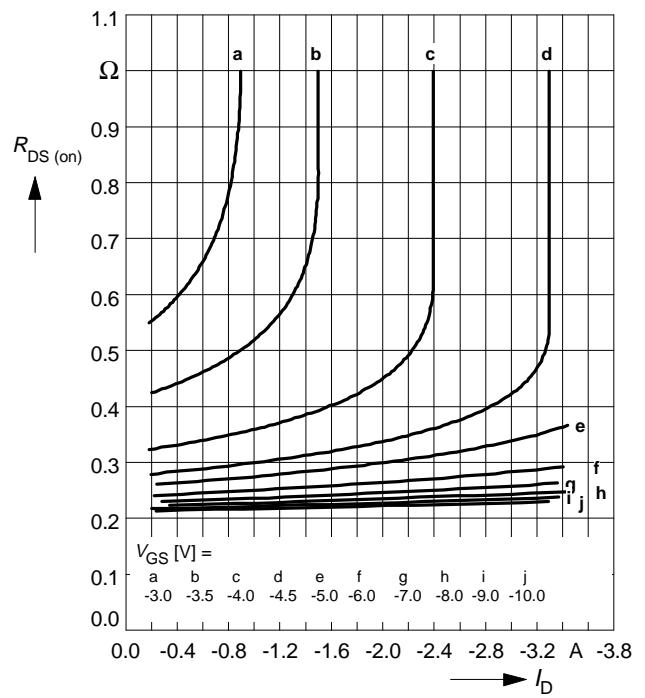
parameter:  $t_p = 80 \mu s$



### Typ. drain-source on-resistance

$$R_{DS(on)} = f(I_D)$$

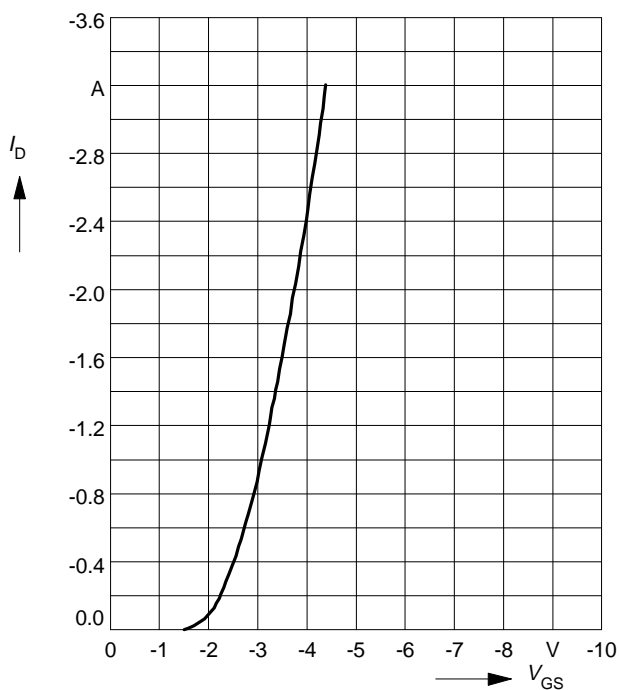
parameter:  $t_p = 80 \mu s, T_j = 25^\circ C$



### Typ. transfer characteristics $I_D = f(V_{GS})$

parameter:  $t_p = 80 \mu s$

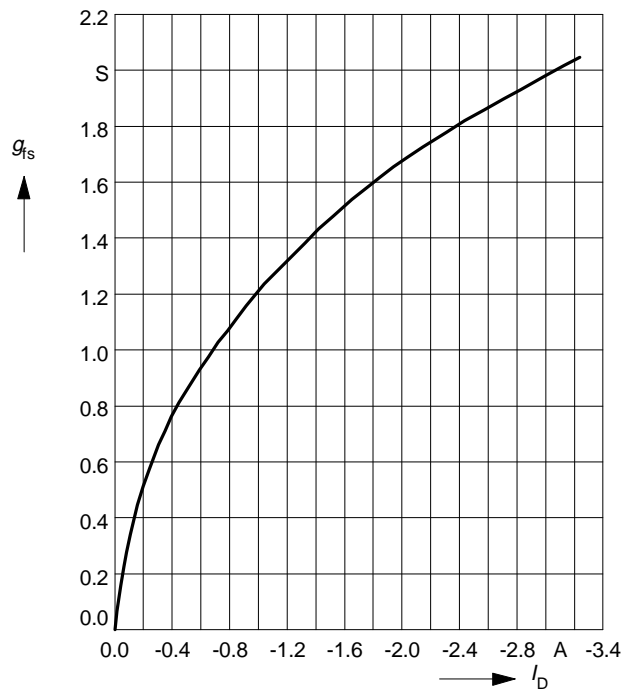
$$V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$$



### Typ. forward transconductance $g_{fs} = f(I_D)$

parameter:  $t_p = 80 \mu s,$

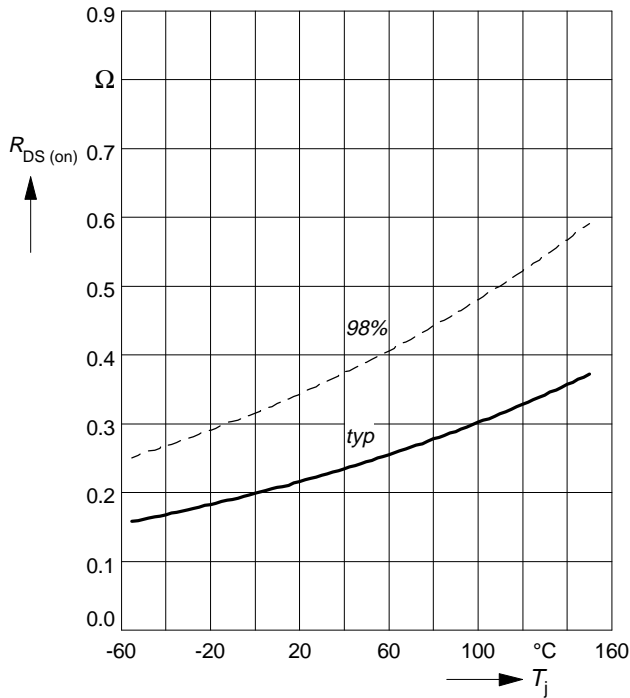
$$V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$$



### Drain-source on-resistance

$$R_{DS(on)} = f(T_j)$$

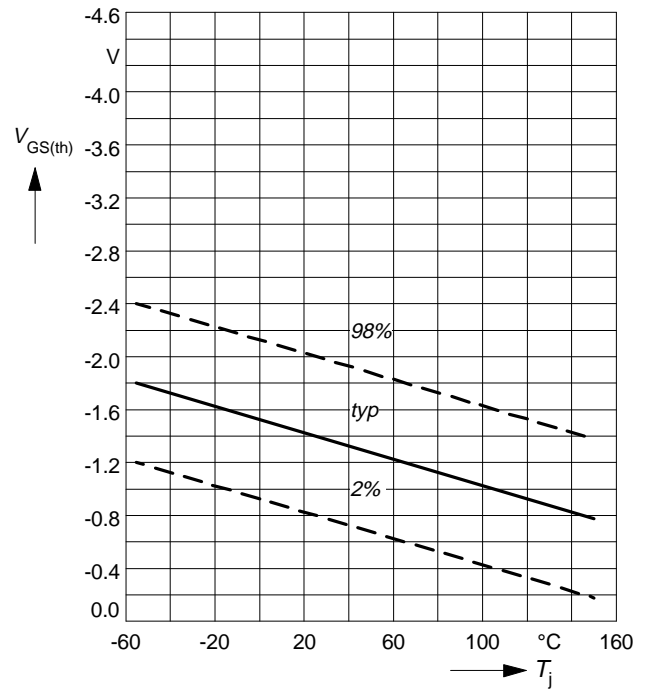
parameter:  $I_D = -1.7 \text{ A}$ ,  $V_{GS} = -10 \text{ V}$



### Gate threshold voltage

$$V_{GS(th)} = f(T_j)$$

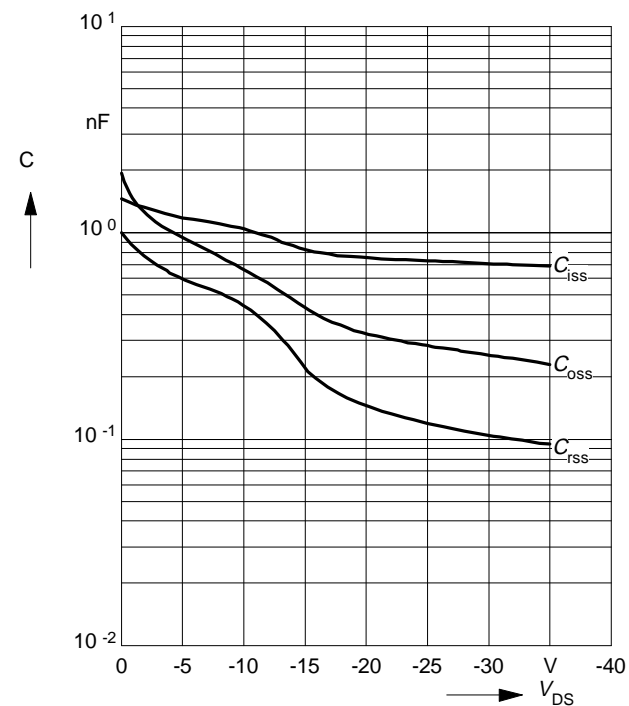
parameter:  $V_{GS} = V_{DS}$ ,  $I_D = -1 \text{ mA}$



### Typ. capacitances

$$C = f(V_{DS})$$

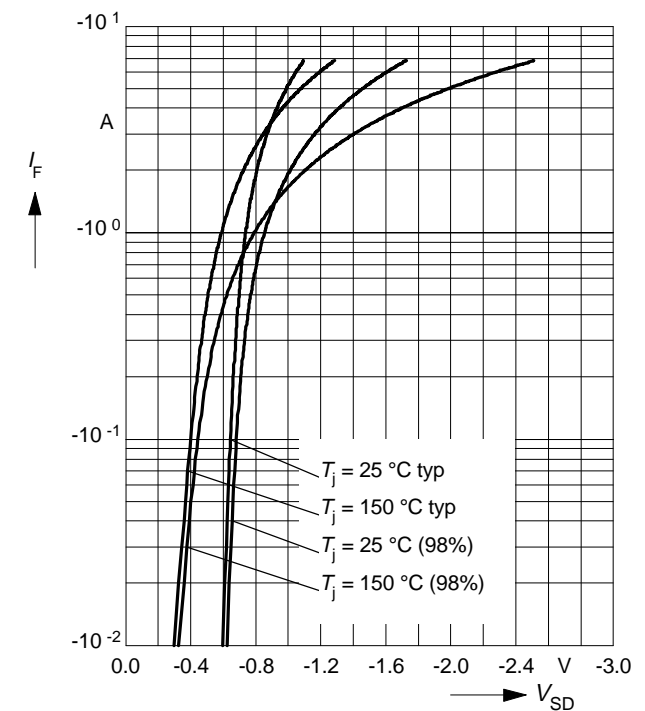
parameter:  $V_{GS}=0\text{V}$ ,  $f = 1 \text{ MHz}$



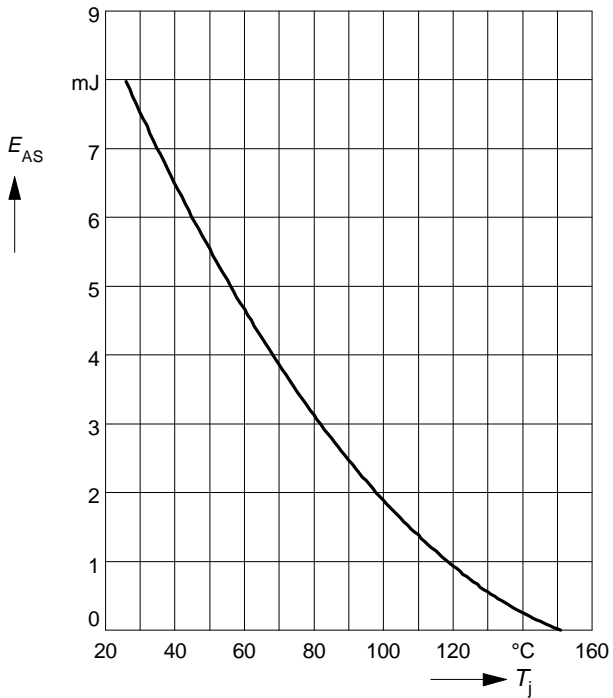
### Forward characteristics of reverse diode

$$I_F = f(V_{SD})$$

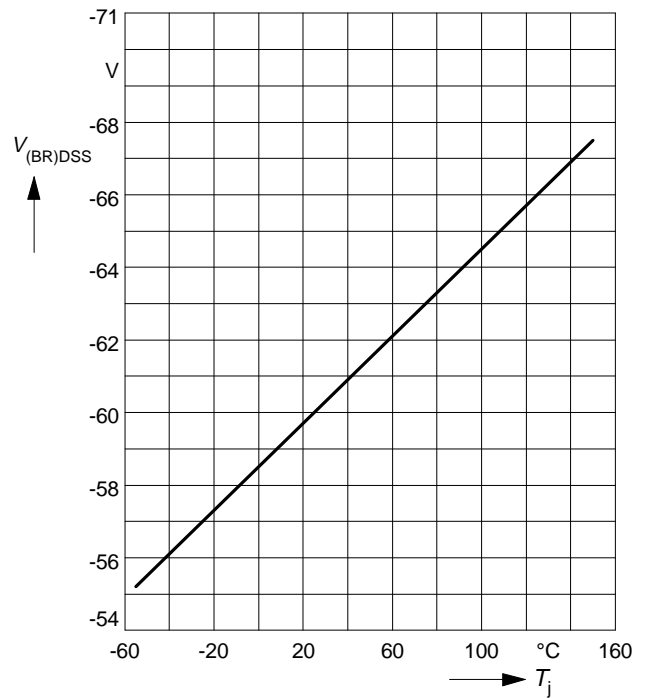
parameter:  $T_j, t_p = 80 \mu\text{s}$



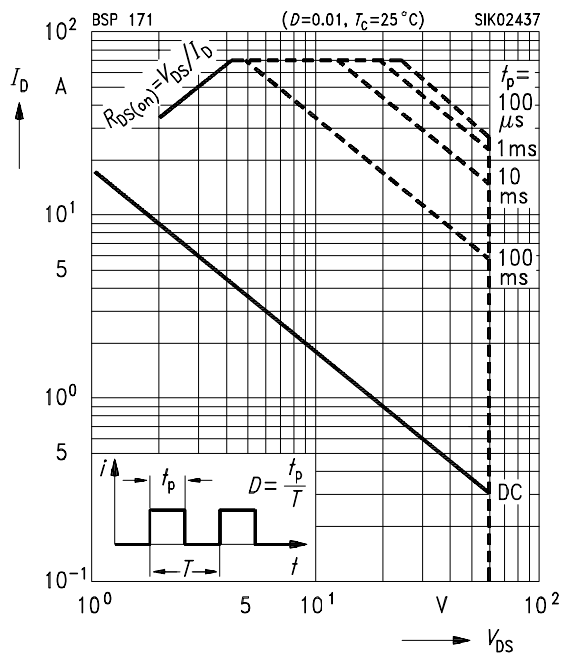
**Avalanche energy**  $E_{AS} = f(T_j)$   
 parameter:  $I_D = -1.7$  A,  $V_{DD} = -25$  V  
 $R_{GS} = 25 \Omega$ ,  $L = 3.23$  mH



**Drain-source breakdown voltage**  
 $V_{(BR)DSS} = f(T_j)$



**Safe operating area**  $I_D = f(V_{DS})$   
 parameter :  $D = 0.01$ ,  $T_C = 25^\circ\text{C}$





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